Display Elektronik GmbH

DATA SHEET

TFT MODULE

DEM 320240P TMH-PW-N

2,3" TFT

Product Specification

Ver.: 1

Revision History

Revision	Date	Originator	Detail	Remarks
0	17.07.2015	МН	Initial Release	-
1	24.05.2016	МН	Modify Interface	P4

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size (Diagonal)	2.3"	-
LCD Type	TN TFT	-
Display Mode	Transmissive / Normally White	-
Resolution	320 x RGB x 240	Pixels
View Direction	6 O'clock	Best Image
Gray Scale Inversion Direction	12 O'clock	-
Module Outline	50.90 x 45.80 x 2.30 (max.) (Note1)	mm
Active Area	46.752 x 35.064	mm
Pixel Size	146.10 x 146.10	mm
Pixel Arrangement	R.G.B. Vertical-Stripe	-
Polarizer Surface Treatment	Normal	-
Display Colors	262k	-
Interface	6-Bit-RGB-Interface (Serial) + 3-Wire-SPI	-
Driver IC	ILI9342C (Ilitek)	-
With or Without Touch Panel	Without	-
Operating Temperature	-20°C to +70°C	°C
Storage Temperature	-30°C to +80°C	°C
Weight	~6	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

Vss=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	3.6	V
Storage Temperature	T _{STG}	-30	80	°C
Operating Temperature	T _{OP}	-20	70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item		Symbol	Min.	Тур.	Max.	Unit
Supply Voltage		VCC	3.0	3.2	3.3	V
Logic Low Input Voltage		VIL	-0.3	-	0.2*VCC	V
Logic High Input Voltage		ViH	0.8*VCC	-	VCC	V
Logic Low Output Voltage		Vol	0	-	0.2VCC	V
Logic High Output Voltage		Vон	0.8*VCC	-	VCC	V
Current Consumption All Black	Logic Analog	I _{CC+} I _{IN}	-	(6)	-	mA

5. Backlight Characteristic

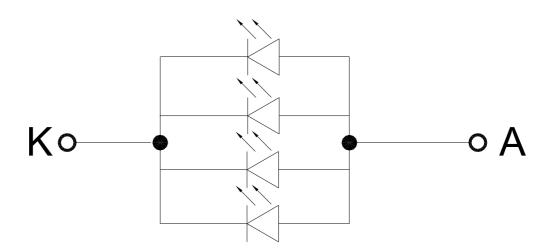
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, I _F =20mA/LED	2.9	3.2	3.4	V
Forward Current	lF	Ta=25 °C, V _F =3.2V/LED	-	80	-	mA
Power Dissipation	PD		-	256	-	mW
Uniformity	Avg		75	80	-	%
LED Lifetime (25°C)	-		-	30,000	-	Hrs
Drive Method	Constant Current					
LED Configuration		4 White LED	s in Para	allel		

Note: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25±2°C, 60%RH±5%, IF=20mA.

5.2. Backlighting Circuit



6. Optical Characteristics

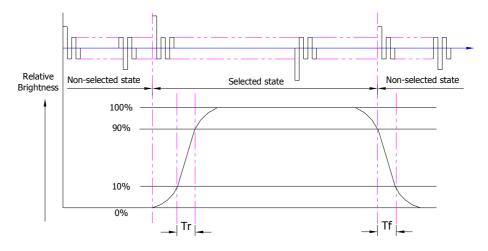
6.1. Optical Characteristics

Ta=25°C, VCC=3.2V, TN LC+ Polarizer

	ltom		Cymbal	Condition	S	pecificati	on	l loit
	Item		Symbol	Condition	Min.	Тур.	Max.	Unit
	Luminand	ce on						
(1	$TFT(I_f=20mA/LED)$		Lv	Normally	240	300	-	cd/m²
ode	Contrast Ratio	(See 6.3)	CR	viewing angle	400	500	-	
Backlight On (Transmissive Mode)	Response (See 6		TR+TF	θx =φy =0°	-	20	30	ms
nis		Red	XR		(0.508)	(0.558)	(0.608)	
ınsı		Reu	YR		(0.263)	(0.313)	(0.363)	
Tra	Chromaticity	Green	XG		(0.252)	(0.302)	(0.352)	
) uC	Transmissive	Gleen	YG		(0.578)	(0.628)	(0.678)	
ht 0	(See 6.5)	Blue	Хв		(0.095)	(0.145)	(0.195)	
lig	(000 0.5)	Diue	ΥB		(0.051)	(0.101)	(0.151)	
ack		White	Xw		(0.207)	(0.257)	(0.307)	
В		vviile	Yw		(0.269)	(0.319)	(0.369)	
	Viewing	Horizont	θx+		60	70	-	
	Angle	al	θx-	Center CR≥10	60	70	-	Deg.
	(See 6.4)	Vertical	фҮ+	John ONE 10	60	70	-	Dog.
	(355 0.4)	vertical	φY-		50	60	-	
	NTSC Ratio	(Gamut)			-	45	50	%

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

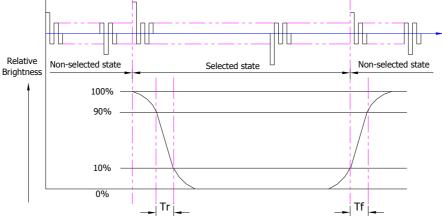


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

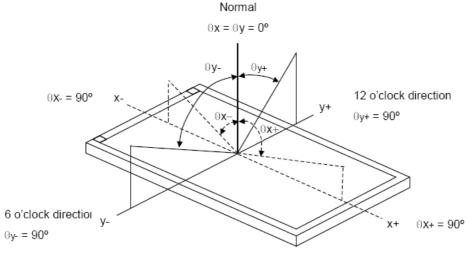
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent		
Measuring Point Diameter	3mm//1mm		
Measuring Point Location	Active Area centre point		
Toot pottorn	A: All Pixels white		
Test pattern	B: All Pixel black		
Contrast setting	Maximum		

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles

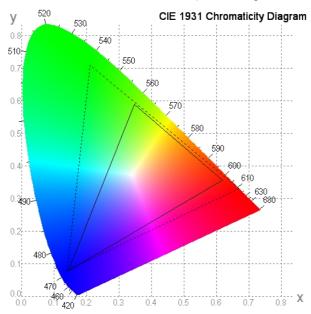


Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

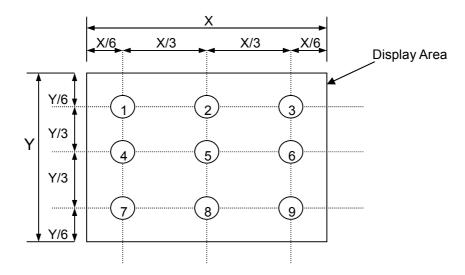


6.6. Definition of Surface Luminance, Uniformity and Transmittance

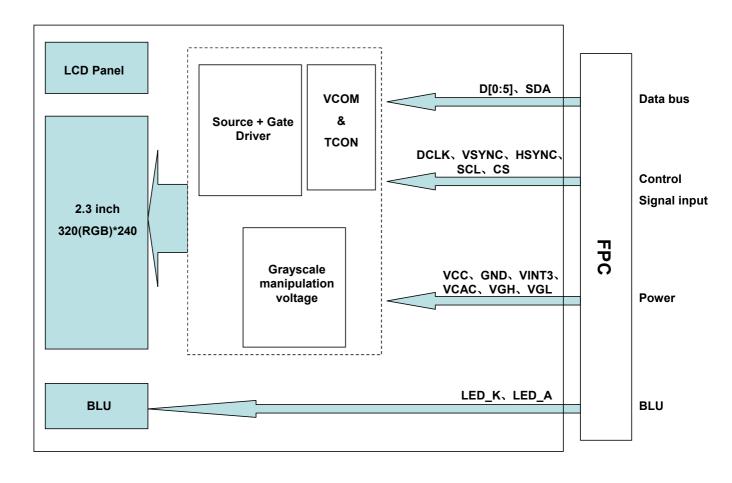
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: L_V = average (L_{P1} : L_{P9})
- 6.6.2. Uniformity = Minimal $(L_{P1}:L_{P9})$ / Maximal $(L_{P1}:L_{P9})$ * 100%
- 6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply

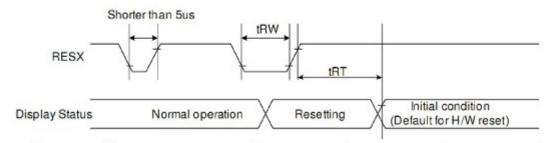


8. Interface Pins Definition

No.	Symbol	Function	Remark
1	NC	No connection.	
2	NC	No connection.	
3	D0	Data bus.	
4	D1	Data bus.	
5	D2	Data bus.	
6	D3	Data bus.	
7	D4	Data bus.	
8	D5	Data bus.	
9	DCLK	Pixel Clock Signal.	
10	VSYNC	Vertical Sync Signal.	
11	HSYNC	Horizontal Sync Signal.	
12	SCL	Serial Communication Clock Input.	
13	SDA	Serial Communication Data Input and Output.	
14	CS	Chip select signal.	
15	VCC	Supply voltage.	
16	GND	Ground.	
17	NC	No connection.	
18	LED_K	LED Cathode.	
19	GND	Ground.	
20	LED_A	LED Anode.	
21	NC	No connection.	
22	NC	No connection.	
23	NC	No connection.	
24	C1M	Connect the charge-pumping capacitor on C11P/C11N for	
25	C1P	generating DDVDH level.	
26	NC	No connection.	
27	C2M	Connect the charge-pumping capacitor on C31P/C31N for	
28	C2P	generating DDVDH 3X level.	
29	NC	No connection.	
30	C3M	Connect the charge-pumping capacitor on C21P/C21N for	
31	C3P	generating VGH, VGL level.	
32	VINT3	Power supply for the source driver and VCOM driver.	
33	VCAC	A power supply pin for generating GVCL.	
34	NC	No connection.	
35	VGH	Supply for The Gate Driver.	
36	C4M	Connect the charge-pumping capacitor on C22P/C22N for	
37	C4P	generating DDVDL 3X level.	
38	VGL	Supply for The Gate Driver.	
39	NC	No connection.	
40	NC	No connection.	

9. Timing Characteristics

9.1 Reset Timing

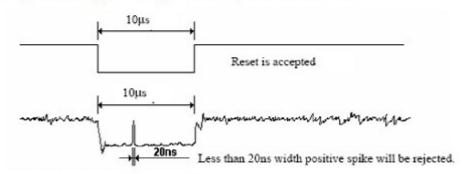


Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	Deset sensel		5 (note 1,5)	mS	
	tRT	Reset cancel		120 (note 1,6,7)	mS

- Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

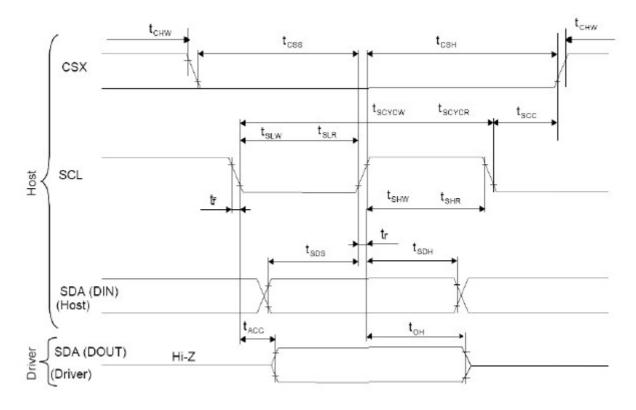
RESX Pulse	Action	
Shorter than 5us	Reset Rejected	
Longer than 10us	Reset	
Between 5us and 10us	Reset starts	

- Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out -mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.
- Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



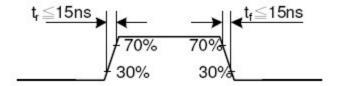
- Note 5: When Reset applied during Sleep In Mode.
- Note 6: When Reset applied during Sleep Out Mode.
- Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

9.2 Display Serial Interface Characteristics(3-line SPI system)

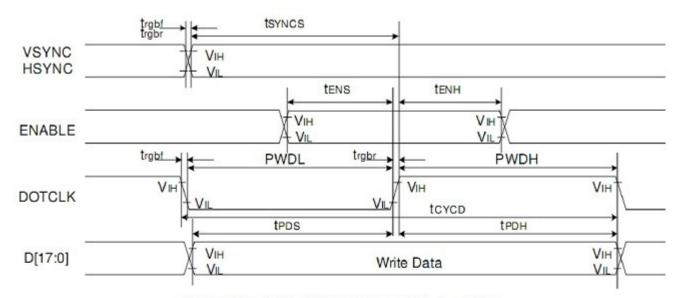


Signal	Symbol	Parameter	min	max	Unit	Description
601	tscycw	Serial Clock Cycle (Write)	100		ns	
	tshw	SCL "H" Pulse Width (Write)	35	-	ns	
	tslw	SCL "L" Pulse Width (Write)	35	74	ns	
SCL	tscycr	Serial Clock Cycle (Read)	150	(4	ns	
	tshr	SCL "H" Pulse Width (Read)	60	- 12	ns	
	tslr	SCL "L" Pulse Width (Read)	60	12	ns	
SDA	tsds	Data setup time (Write)	30	- 25	ns	
(Input)	tsdh	Data hold time (Write)	30	37 8	ns	
SDA	tacc	Access time (Read)	10	-	ns	
(Output)	toh	Output disable time (Read)	15	50	ns	
V2 (0) (0)	tscc	SCL-CSX	20	74	ns	
COV	tchw	CSX "H" Pulse Width	40	(4	ns	
CSX	tcss	CSV SCI Time(verite)	30	12	ns	
	tcsh	CSX-SCL Time(write)	30	-	ns	

Note: Ta = 25 °C, IOVCC=1.65V to 2.8V, VCI=2.6V to 3.3V, AGND=GND=0V



9.3 Parallel Interface Characteristics (6bit RGB Interface)



(VCI=3.0 to 3.3V, IOVCC=3.0 to 3.3V, Ta=25℃)

Signal	Symbol	Parameter	min	max	Unit	Description	
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15		ns		
HSYNC	tsynch	VSYNC/HSYNC hold time	15		ns		
DE	tens	DE setup time	15		ns]	
DE	tenh	DE hold time	15		ns		
D(17:01	teos	Data setup time 1			ns	18/16-bit bus RGB	
D[17:0]	t _{PDH}	Data hold time	15	0.50	ns	interface mode	
	PWDH	DOTCLK high-level period	33		ns	interrace mode	
	PWDL	DOTCLK low-level period	33	-	ns]	
DOTCLK	toyop	DOTCLK cycle time(18 bit)	100		ns		
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	1	
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15 - ns				
HSYNC	tsynch	VSYNC/HSYNC hold time	15		ns		
DE	tens	DE setup time	15		ns]	
DE	tenh	DE hold time	15		ns		
D[4.7.0]	teos	Data setup time	15		ns	6-bit bus RGB	
D[17:0]	tерн	Data hold time	15		ns	interface mode	
DOTCLK	PWDH	DOTCLK high-level pulse period	25	-	ns		
	PWDL	DOTCLK low-level pulse period	25		ns]	
	CLK tcycp DOTCLK cycle time		50		ns]	
	trabr , trabf	DOTCLK,HSYNC,VSYNC rise/fall time		15	ns		

10. Quality Assurance

10.1 Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2 Standard for Quality Test

10.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, normal inspection

10.2.2 Sampling Criteria:

Visual inspection: AQL 1.5% Electrical functional: AQL 0.65%.

10.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3 Nonconforming Analysis & Disposition

- 10.3.1 Nonconforming analysis:
 - 10.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.
 - 10.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 10.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.
- 10.3.2 Disposition of nonconforming:
 - 10.3.2.1 Non-conforming product over PPM level will be replaced.
 - 10.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4 Agreement Items

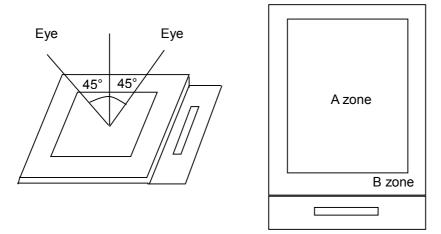
Shall negotiate with customer if the following situation occurs:

- 10.4.1 There is any discrepancy in standard of quality assurance.
- 10.4.2 Additional requirement to be added in product specification.
- 10.4.3 Any other special problem.

10.5 Standard of the Product Visual Inspection

10.5.1 Appearance inspection:

- 10.5.1.1 The inspection must be under illumination about $1000 1500 \, lx$, and the distance of view must be at $30 \, cm \pm 2 \, cm$.
- 10.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
- 10.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,



10.5.2 Basic principle:

- 10.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.
- 10.5.2.2 New item must be added on time when it is necessary.

10.6 Inspection Specification

No.	Item	Criteria (Unit: mm)		
	Black / White spot Foreign material	а	Area Size φ≤0.10	Acc. Qty
	(Round type) Pinholes Stain Particles inside cell.		0.10<φ≤0.15	2
01			0.15<φ≤0.25	1
		l b l	0.25<φ	0
			Total	2 no include
	(Minor defect)	φ = (a + b)/2	iotai	φ≤ 0.10
	(Willion delect)		<u>-</u>	
		Distance between 2 defect	ts should more than 3mm	apart.

			Display Area	Total	
		Bright dot	0	0],,,,
		Dark dot	N≤2	N≤2	Note1
00	Electrical Defect	Total dot	N≤2	N≤2	
02	(Minor defect)	Mura	Not visible through	5% ND filters.	Note2
		Remark: 1. Bright dot cause	ed by scratch and forei	gn object accord	s to item 1.
03	Black and White line Scratch Foreign material (Line type)	W L		-	
	(Minor defect)	Length /	Width W ≤ 0.03	Acc. Qty	
		L ≦ 2.5	$0.03 < W \le 0.05$		
		L ≦ 2.5	$0.05 < W \le 0.00$		
		/	0.1 < W	0	
		,	Total	3	
			defects should more the back of the display ar	nan 3mm apart. S	Scratches not
04	Glass Crack (Minor defect)	Crack is potential to	enlarge, any type is no	ot allowed.	

	Glass Chipping Pad Area:			
	(Minor defect)	Length and Width	Acc. Qty	
		c > 3.0, b< 1.0	1	
05		c< 3.0, b< 1.0	3	
		a <glass td="" thick<=""><td>ness</td></glass>	ness	
	b			
	Glass Chipping Rear of Pad Area: (Minor defect)			
		Length and Width	Acc. Qty	
		c > 3.0, b< 1.0	1	
06		c< 3.0, b< 1.0	2	
		c< 3.0, b< 0.5	4	
	h c	a <glass td="" thickness<=""></glass>		
	Glass Chipping Except Pad Area: (Minor defect)			
	(Willief delect)	Length and Width	Acc. Qty	
		c > 3.0, b< 1.0	1	
07		c< 3.0, b< 1.0	2	
	b b	c< 3.0, b< 0.5	4	
		a <glass td="" thick<=""><td>ness</td></glass>	ness	
	Class Corner Chinning			
	Glass Corner Chipping: (Minor defect)			
08	(WILLION GENECAL)	Length and Width	Acc. Qty	
		c < 3.0, b< 3.0	Ignore	
		a <glass td="" thick<=""><td>_</td></glass>	_	
	ba			

	Glass Burr:						
	(Minor defect)			Langth	Ass Ohi		
		//		Length	Acc. Qty		
				F < 1.0	Ignore		
	F						
09	_						
	→	F —					
				don't affect as	semble and module		
			dimension.				
	FPC Defect:						
	(Minor defect)						
	$a \rightarrow c \leftarrow c$		10.1 Dent, pinhole width a <w 3.<="" td=""></w>				
			(w: circuitry	width.)			
10			10.2 Open circuit is unacceptable.				
			10.3 No oxidation, contamination and distortion.				
			Diamete	Acc. Q	ty		
	Bubble on Polarizer		φ≤0.20	Ignore	<u> </u>		
11	(Minor defect)		0.20 <φ≤0.				
	(0.30 <φ≤0.				
			0.50 < φ	None			
12			Diamete	Acc. Q	ty		
	Dent on Polarizer (Minor defect)		φ≤0.20 Ignore				
			0.20 <φ≤0.				
			0.30 <φ≤0.				
			0.50 < φ	None	!		
12	Pozel	13.1 No rust, distort	ion on the Be	zel.			
13	Bezel	13.2 No visible finge	erprints, stains	s or other contami	nation.		

		T
		D: Diameter W: width L: length
		14.1 Spot: D<0.25 is acceptable
		0.25≤D≤0.4
		2dots are acceptable and the distance between defects should more than
		10 mm.
14	Touch Panel	D>0.4 is unacceptable
		14.2 Dent: D>0.40 is unacceptable
		14.3 Scratch: W≤0.03, L≤10 is acceptable,
		0.03 <w≤0.10, acceptable<="" is="" l≤10="" td=""></w≤0.10,>
		Distance between 2 defects should more than 10 mm.
		W>0.10 is unacceptable.
		·
	РСВ	15.1 No distortion or contamination on PCB terminals.
4.5		15.2 All components on PCB must same as documented on the
15		BOM/component layout.
		15.3 Follow IPC-A-600F.
16	Soldering	Follow IPC-A-610C standard
	Electrical Defect (Major defect)	The below defects must be rejected.
		17.1 Missing vertical / horizontal segment,
		17.2 Abnormal Display.
17		17.3 No function or no display.
		17.4 Current exceeds product specifications.
		17.5 LCD viewing angle defect.
		17.6 No Backlight.
		17.7 Dark Backlight.
		17.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7 Classification of Defects

- 10.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2 Two minor defects are equal to one major in lot sampling inspection.

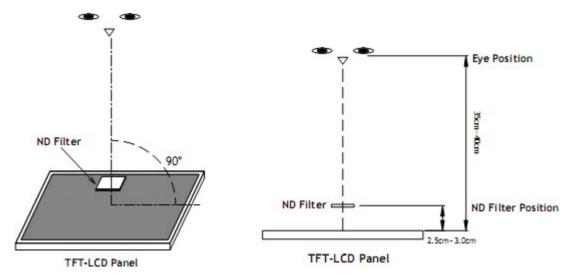
10.8 Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

10.9 Packaging

- 10.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2 Modules inside package box should have compliant mark.
- 10.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70°C, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	50°C, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	80°C, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-20°C, 60min~70°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Floatrical Static Discharge	Air: \pm 8KV 150pF/330 Ω 5 times	2	GB/T17626.2
0	Electrical Static Discharge	Contact: \pm 4KV 150pF/330 Ω 5 times		-2006
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1 Safety

- 12.1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2 Handling

12.2.1 Reverse and use within ratings in order to keep performance and prevent damage.

12.2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3 Storage

12.3.1 Do not store the LCD module beyond the specified temperature ranges.

12.4 Metal Pin (Apply to Products with Metal Pins)

12.4.1 Pins of LCD and Backlight

12.4.1.1 Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2 Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

Maximum Solder Temperature: 370°C

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3 Solder Wetting

Solder Pin Lead

Recommended

Solder Pin Lead

Not Recommended

12.4.2 Pins of EL

12.4.2.1 Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2 No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3 Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: $270{\sim}290\,{^{\circ}\!{\rm C}}$

Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4 No horizontal press on the EL leads during soldering.

12.4.2.5 180° bend EL leads three times is not allowed.

12.4.2.6 Solder Wetting



Recommended

Not Recommended

12.4.2.7 The type of the solder iron:



Recommended

Not Recommended

12.4.2.8 Solder Pad



12.5 Operation

- 12.5.1 Do not drive LCD with DC voltage
- 12.5.2 Response time will increase below lower temperature
- 12.5.3 Display may change color with different temperature
- 12.5.4 Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

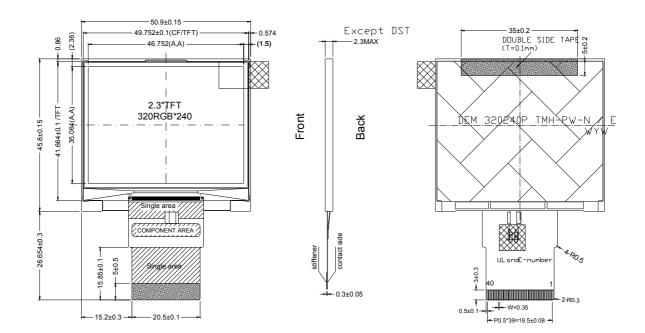
12.6 Static Electricity

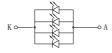
- 12.6.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2 The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7 Limited Warranty

- 12.7.1 Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2 If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3 After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

13. Outline Drawing





NOTES:

1.Display Type: 2.3"TFT

2. Viewing Direction: 6 O'CLOCK

3. Grayscale Inversion Direction: 12 O'CLOCK

4. Polarizer mode: Transmissive/Normal white / Anti-Glare

5.Operation Temperature: -20°C to +70°C

6.Storage Temperature: -30°C to +80°C

7.Driver/Controller IC: ILI9342C (Ilitek)

8.Logic Power Supply Voltage: 3.2 Volt (typ.)

9.Backlight: White, Lightguide (4LEDs, 80mA, 3.2Volt (typ.))

10.Brightness: 300cd/m2 (typ.) 11.LED Lifetime: 30.000h (typ.)

* Unspecification tolerance are ± 0.2mm

Pin assignment				
PIN	SYMBOL			
1	NC			
2	NC			
3	D0			
4	D1			
5	D2			
6	D3			
7	D4			
8	D5			
9	DCLK			
10	VSYNC			
11	HSYNC			
12	SCL			
13	SDA			
14	CS			
15	VCC			
16	GND			
17	NC			
18	LED_K			
19	GND			
20	LED_A			
21	NC			
22	NC			
23	NC			
24	C1M			
25	C1P			
26	NC			
27	C2M			
28	C2P			
29	NC			
30	C3M			
31	C3P			
32	VINT3			
33	VCAC			
34	NC			
35	VGH			
36	C4M			
37	C4P			
38	VGL			
39	NC			
40	NC			